

Type	Hits	Search Text	DBs	Time
165	BRS 2	"6016308"	USPAT	2002/01
166	BRS 1	"6106308"	USPAT	2002/01
167	BRS 1	"6221750"	USPAT	2002/01
168	BRS 1	"5590460".PN.	USPAT	2002/01
169	BRS 1	"5597470".PN.	USPAT	2002/01
170	BRS 1	"5629239".PN.	USPAT	2002/01
171	BRS 1	"5679194".PN.	USPAT	2002/01
172	BRS 1	"5956605".PN.	USPAT	2002/01
173	BRS 1	"6011300".PN.	USPAT	2002/01
174	BRS 1	"6023028".PN.	USPAT	2002/01
175	BRS 1	"6046507".PN.	USPAT	2002/01
176	BRS 1	"6093971".PN.	USPAT	2002/01
177	BRS 1	"5763941".PN.	USPAT	2002/01
178	BRS 1	5518964.pn.	USPAT	2002/01
179	BRS 8	"3747202"	USPAT	2002/01
180	BRS 3	semiconductor and (lead with flexible) and (lead with (curve or curved)) and (wafer with probe)	USPAT	2002/01
181	BRS 3	semiconductor and (lead with flexible) and (lead with (curve or curved)) and (wafer with probe)	USPAT	2002/01
182	BRS 0	(5763941.pn.) and pad	USPAT	2002/01
183	BRS 1	"5120678".PN.	USPAT	2002/01
184	BRS 1	"5148265".PN.	USPAT	2002/01
185	BRS 1	"5148266".PN.	USPAT	2002/01
186	BRS 1	"5194930".PN.	USPAT	2002/01
187	BRS 1	"5203076".PN.	USPAT	2002/01
188	BRS 1	"5249101".PN.	USPAT	2002/01
189	BRS 1	"5249101".PN.	USPAT	2002/01
190	BRS 1	"5288944".PN.	USPAT	2002/01
191	BRS 1	"5289346".PN.	USPAT	2002/01
192	BRS 1	"5385869".PN.	USPAT	2002/01
193	BRS 1	6106308.pn.	USPAT	2002/01
194	BRS 10	("3825353" or "3952404" or "5148265" or "5148266" or "5518964" or "4700473" or "5053922" or "392588	USPAT	2002/01
195	BRS 1	(5834339.pn.) and flexible	USPAT	2002/01
196	BRS 1	"4893172".PN.	USPAT	2002/01
197	BRS 1	"5610436".PN.	USPAT	2002/01
198	BRS 1	"3628105".PN.	USPAT	2002/01
199	BRS 1	"4912547".PN.	USPAT	2002/01
200	BRS 1	"5390844".PN.	USPAT	2002/01
201	BRS 1	"5394009".PN.	USPAT	2002/01
202	BRS 1	"5398863".PN.	USPAT	2002/01
203	BRS 1	"5489749".PN.	USPAT	2002/01
204	BRS 1	"5491302".PN.	USPAT	2002/01
205	BRS 1	"5518964".PN.	USPAT	2002/01
206	BRS 1	"5536909".PN.	USPAT	2002/01
207	BRS 1	"5798751".PN.	USPAT	2002/01

	Type	Hits	Search Text	DBs	Time
188	BRS	1	"5249101".PN.	USPAT	2002/04
189	BRS	1	"5249101".PN.	USPAT	2002/04
190	BRS	1	"5288944".PN.	USPAT	2002/04
191	BRS	1	"5289346".PN.	USPAT	2002/04
192	BRS	1	"5385869".PN.	USPAT	2002/04
193	BRS	1	6106308.pn.	USPAT	2002/04
194	BRS	10	("3825353" or "3952404" or "5148265" or "5148266" or "5518964" or "4700473" or "5053922" or "392588	USPAT	2002/04
195	BRS	1	(5834339.pn.) and flexible	USPAT	2002/04
196	BRS	1	"4893172".PN.	USPAT	2002/04
197	BRS	1	"5610436".PN.	USPAT	2002/04
198	BRS	1	"3628105".PN.	USPAT	2002/04
199	BRS	1	"4912547".PN.	USPAT	2002/04
200	BRS	1	"5390844".PN.	USPAT	2002/04
201	BRS	1	"5394009".PN.	USPAT	2002/04
202	BRS	1	"5398863".PN.	USPAT	2002/04
203	BRS	1	"5489749".PN.	USPAT	2002/04
204	BRS	1	"5491302".PN.	USPAT	2002/04
205	BRS	1	"5518964".PN.	USPAT	2002/04
206	BRS	1	"5536909".PN.	USPAT	2002/04
207	BRS	1	"5798751".PN.	USPAT	2002/04
208	BRS	1	"5878486".PN.	USPAT	2002/04
209	BRS	3	((formfactor.as.) or ((form adj factor).as.)) and (plane with (curved or bent))	USPAT	2002/04
210	BRS	0	(semiconductor) and ((plane with (curved or bent) with (surface or face) with parallel with lead) with (flexible or	USPAT	2002/04
211	BRS	10	(semiconductor) and ((plane with (curved or bent) with (surface or face) with parallel with lead) same (flexible	USPAT	2002/04
212	BRS	0	(dozier.in.) and (lead with beam)	USPAT	2002/04
213	BRS	1	(dozier.in.) and (lead with strip)	USPAT	2002/04
214	BRS	1	((formfactor.as.) or ((form adj factor).as.)) and (lead with strip)	USPAT	2002/04
215	BRS	0	((formfactor.as.) or ((form adj factor).as.)) and (lead with beam)	USPAT	2002/04
216	BRS	1	((formfactor.as.) or ((form adj factor).as.)) and (lead with cantilever)	USPAT	2002/04
217	BRS	1	((formfactor.as.) or ((form adj factor).as.)) and (lead with flat)	USPAT	2002/04
218	BRS	0	lead with flat with because	USPAT	2002/04
219	BRS	0	lead with flat with provide	USPAT	2002/04
220	BRS	0	(lead with flat with reduce) and (wafer with probe)	USPAT	2002/04
221	BRS	0	(lead with flat with reduce) and (tessera.as.)	USPAT	2002/04
222	BRS	8	((honda and minoru).in.) and (hitachi.as.)	USPAT	2002/04
223	BRS	0	((honda and minoru).in.) and (hitachi.as.) and (mount or mounting or mounted)	EPO	2002/04
224	BRS	2	((honda and minoru).in.) and (hitachi.as.) and (mount or mounting or mounted)	JPO; DERWENT	2002/04
225	BRS	0	"57121255"	USPAT	2002/04
226	BRS	0	"jp57121255"	USPAT	2002/04
227	BRS	2	"57121255"	EPO; JPO; DERWENT	2002/04
228	BRS	1	5772451.pn. and flat	USPAT	2002/04
229	BRS	1	5772451.pn. and probe	USPAT	2002/04
230	BRS	1	5772451.pn. and wafer	USPAT	2002/04

Type	Mils	Search Text	DMS	Time Stamp	Comments	Group Defined	Errors
DRB	0	"0978510s"					
DRB	1	6221750.pn.					USPAT
DRB	48	(rjelated and joseph).in.					USPAT
DRB	45	(rjelated and joseph).in. and (tessera.as.)					USPAT
DRB	1	3952404.pn.					USPAT
DRB	179	lead with sacrificial					USPAT
DRB	1	re35119.pn.					USPAT
DRB	1	3625353.pn.					USPAT
DRB	1	3952404.pn.					USPAT
DRB	1	5148265.pn.					USPAT
DRB	1	5148266.pn.					USPAT
DRB	1	5518964.pn.					USPAT
DRB	1	4700473.pn.					USPAT
DRB	1	5063922.pn.					USPAT
DRB	1	3925880.pn.					USPAT
DRB	1	3250847.pn.					USPAT
DRB	1	5626000.pn.					USPAT
DRB	103	"40761"					EPO; DERIVENT
DRB	0	99/40761					EPO; DERIVENT
DRB	17	((beam adj lead) and sacrificial					USPAT
DRB	9	"5250847"					USPAT
DRB	1	4994895.pn.					USPAT
DRB	1	4950991.pn.					USPAT
DRB	1	4980753.pn.					USPAT
DRB	472	2577784.ccls.					USPAT
DRB	5	2577784.ccls. and ((beam adj lead)					USPAT
DRB	144	((beam adj lead)					USPAT
DRB	68	((beam adj lead) and ((beam adj lead).ti.					USPAT
DRB	211	((beam adj lead) and ((apparatus).ti.					USPAT
DRB	235	((beam adj lead) and ((beam adj lead).ab.)					USPAT
DRB	198	((beam adj lead) and ((beam adj lead).ab.) not ((beam adj lead) and ((apparatus).ti.)					USPAT
DRB	37	((((beam adj lead) and ((beam adj lead).ab.) not ((beam adj lead) and ((apparatus).ti.)) and perpendicular					USPAT
DRB	21	"3952404"					USPAT
DRB	1	5057460.pn.					USPAT
DRB	1	5055907.pn.					USPAT
DRB	1	5049005.pn.					USPAT
DRB	1	5047830.pn.					USPAT
DRB	1	4995523.pn.					USPAT
DRB	1	4955523.pn.					USPAT
DRB	1	4954877.pn.					USPAT
DRB	1	4949158.pn.					USPAT
DRB	1	4926241.pn.					USPAT
DRB	1	"00000000"					USPAT

Type Hits				Search Text	
13	PRR	1	4893172.pn.	USPAT	
14	PRR	1	4812191.pn.	USPAT	
15	PRR	5	(beam adj lead) and actuator	EPO; JPO; DERWENT; IBM TOS	
16	PRR	56	(beam adj lead) with flexible	EPO; JPO; DERWENT; IBM TOS	
17	PRR	0	"0352020"	EPO	
18	PRR	0	ep0352020.pn.	EPO	
19	PRR	0	ep0352020	EPO	
20	PRR	0	"0352020"	EPO	
21	PRR	1	"352020"	EPO	
22	PRR	0	"40761" and ("08" with "12" with "1999")	EPO; DERWENT	
23	PRR	103	"40761"	EPO; DERWENT	
24	PRR	2	"9940761"	EPO; DERWENT	
25	PRR	2	"0903091"	EPO; DERWENT	
26	PRR	1	swlampour.in.	USPAT	
27	PRR	23	karavakis.in.	USPAT	
28	PRR	109	((beam adj lead) and ((beam adj lead).ab.)) not ((apparatus).ti. or (apparatus).ab.)	USPAT	
29	PRR	12	((beam adj lead) and ((beam adj lead).ab.)) not ((apparatus).ti. or (apparatus).ab.) and (suspend or sus	USPAT	
30	PRR	2	"9940761"	DERWENT	
31	PRR	0	(vol with "36") and (no with "7")	IBM TOS	
32	PRR	1	3373481.pn.	USPAT	
33	PRR	1	3795037.pn.	USPAT	
34	PRR	1	3811106.pn.	USPAT	
35	PRR	1	3952406.pn.	USPAT	
36	PRR	1	4067104.pn.	USPAT	
37	PRR	1	4142208.pn.	USPAT	
38	PRR	1	4326663.pn.	USPAT	
39	PRR	1	4447857.pn.	USPAT	
40	PRR	1	4520362.pn.	USPAT	
41	PRR	1	4629957.pn.	USPAT	
42	PRR	1	4661192.pn.	USPAT	
43	PRR	1	4667219.pn.	USPAT	
44	PRR	1	4721995.pn.	USPAT	
45	PRR	1	4751199.pn.	USPAT	
46	PRR	1	4785137.pn.	USPAT	
47	PRR	1	4793814.pn.	USPAT	
48	PRR	1	4812191.pn.	USPAT	
49	PRR	218	((beam adj lead) and ((beam adj lead).clm.)) not ((apparatus).ti. or (apparatus).ab.)	USPAT	
50	PRR	26	((beam adj lead) and ((beam adj lead).clm.)) not ((apparatus).ti. or (apparatus).ab.) and ((beam adj lead	USPAT	
51	PRR	160	tessera.as.	USPAT	
52	PRR	50	tessera.as. and (lead.ti.)	USPAT	
53	PRR	22	tessera.as. and (beam adj lead)	USPAT	
54	PRR	405	257/780.ccls.	USPAT	
55	PRR	17	257/780.ccls. and (beam adj lead)	USPAT	

Type	File	Search Text	DBs
ERR 17	sacrificial and (beam adj lead)	USPAT	
ERR 31	lead with parallel with cantilever	USPAT	
ERR 0	((semiconductor adj device) and (lead with parallel with cantilever)	USPAT	
ERR 19	((semiconductor adj device) and (lead with parallel) and (lead with cantilever)	USPAT	
ERR 41	(wafer adj probe).ti	USPAT	
ERR 123	(semiconductor and actuator).ab.	USPAT	
ERR 432	(semiconductor and transducer).ab.	USPAT	
ERR 250	((semiconductor and transducer).ab.) and lead	USPAT	
ERR 1	((semiconductor and transducer).ab.) and lead and (beam adj lead)	USPAT	
ERR 33	((semiconductor and transducer).ab.) and (lead with (fabrication or make or making or produce or producing or create))	USPAT	
ERR 23	bassous and (lead with (fabrication or make or making or produce or producing or create))	USPAT	
ERR 0	sacrificial with (lead with (fabrication or make or making or produce or producing or create))	USPAT	
ERR 5	sacrificial with (lead with (fabrication or make or making or produce or producing or create))	USPAT	
ERR 1	5489749.pn.	USPAT	
ERR 1	4356730.pn.	USPAT	
ERR 129	micro mechanical with lead	USPAT	
ERR 24	micro mechanical with lead	USPAT	
ERR 40	jolly and (lead with (fabrication or make or making or produce or producing or create))	USPAT	
ERR 0	distefano and sacrificial	US-PGDB; EPO; JPO; IBN TOR	
ERR 3	sacrificial with (lead with (fabrication or make or making or produce or producing or create))	US-PGDB; EPO; JPO; DERVENT; IBN TOR	
ERR 7	micro mechanical with (lead)	US-PGDB; EPO; JPO; DERVENT; IBN TOR	
ERR 124	cantilever with (lead)	US-PGDB; EPO; JPO; DERVENT; IBN TOR	
ERR 0	(cantilever with (lead)) and sacrificial	US-PGDB; EPO; JPO; DERVENT; IBN TOR	
ERR 22	flexible and (cantilever with (lead))	US-PGDB; EPO; JPO; DERVENT; IBN TOR	
ERR 11	"5602422"	USPAT	
ERR 21	(micro mechanical and gyroscope) and ((lead or connect) with (fabrication or make or making or pr	USPAT; US-PGDB; EPO; JPO; DERVENT; IBN TOR	
ERR 1	re32931.pn.	USPAT	
ERR 1	re33479.pn.	USPAT	
ERR 1	3053095.pn.	USPAT	
ERR 2	257780.ccls. and (micro mechanical)	USPAT	
ERR 3	257784.ccls. and (micro mechanical)	USPAT	
ERR 1	257776.ccls. and (micro mechanical)	USPAT	
ERR 0	257789.ccls. and (micro mechanical)	USPAT	
ERR 0	434338.ccls. and (micro mechanical)	USPAT	
ERR 01	434338.ccls.	USPAT	
ERR 17	438338.ccls.	USPAT	
ERR 1	4893172.pn.	USPAT	
ERR 1	5047740.pn.	USPAT	
ERR 1	5121089.pn.	USPAT	
ERR 1	4070752.pn.	USPAT	
ERR 1	4654676.pn.	USPAT	
ERR 1	5313157.pn.	USPAT	
ERR 109	(flexible and probe).ab. and (semiconductor)	USPAT	
ERR 1	(flexible and probe).ab. and (semiconductor)	USPAT	

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Type	File	Search Text	DB	Time Stamp	Comments	Error Defini	Errors		
123	DBR	1	5313157.pn					USPAT	
124	DBR	109	((flexible and probe).ab. and (semiconductor)					USPAT	
125	DBR	3	((flexible and probe).ab. and (semiconductor) and (sacrificial)					USPAT	
126	DBR	81	((flexible and probe) and (khandron)					USPAT	
127	DBR	19	257773.ccls. and ((beam adj lead) or ((fan adj) (in or out) adj lead))					USPAT	
128	DBR	1	4922753.pn					USPAT	
129	DBR	1	4900177.pn					USPAT	
130	DBR	1	4764184.pn					USPAT	
131	DBR	1	4720908.pn					USPAT	
132	DBR	1	4666737.pn					USPAT	
133	DBR	1	4582563.pn					USPAT	
134	DBR	1	4107726.pn					USPAT	
135	DBR	214	(molybdenum with (pad))					USPAT	
136	DBR	25	(molybdenum with (bonding adj pad))					USPAT	
137	DBR	98	wafer adj probe adj card					USPAT	
138	DBR	1	((essere.as.) and (wafer adj probe adj card)					USPAT	
139	DBR	2	(wafer adj probe adj card).ti.					USPAT	
140	DBR	132	(probe adj card).ti.					USPAT	
141	DBR	111	(probe adj card) with lead					USPAT	
142	DBR	0	"3747202"					USPAT	
143	DBR	81	(beam adj lead) same peripheral					USPAT	
144	DBR	1	5148266.pn					USPAT	
145	DBR	266	(lead with inward with (extend or extended))					USPAT	
146	DBR	61	(lead with inward with (extend or extended)) and (semiconductor adj device)					USPAT	
147	DBR	1	5148266.pn					USPAT	
148	DBR	676	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.					USPAT	
149	DBR	140	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (semiconduc					USPAT	
150	DBR	3	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (semiconduc					USPAT	
151	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent adj b					USPAT	
152	DBR	670	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent with					USPAT	
153	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent with					USPAT	
154	DBR	53	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent with					USPAT	
155	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (dis					USPAT	
156	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (fje					USPAT	
157	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (tee					USPAT	
158	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (bus					USPAT	
159	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because)					USPAT	
160	DBR	82	((deformable or deformed or deform or bent or bendable or bend) with lead with reason)					USPAT	
161	DBR	25	((deformable or deformed or deform or bent or bendable or bend) with lead with reason) and (semi					USPAT	
162	DBR	0	(probe adj card) and (cantilever adj lead)					USPAT	
163	DBR	4	(probe adj card) and (flexible adj lead)					USPAT	
164	DBR	4	(probe adj card) and (flexible adj lead)					USPAT	
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Type	File	Search Text	DB	Time Stamp	Comments	Error Defini	Errors		
165	DBR	1	5313157.pn					USPAT	
166	DBR	109	((flexible and probe).ab. and (semiconductor)					USPAT	
167	DBR	3	((flexible and probe).ab. and (semiconductor) and (sacrificial)					USPAT	
168	DBR	81	((flexible and probe) and (khandron)					USPAT	
169	DBR	19	257773.ccls. and ((beam adj lead) or ((fan adj) (in or out) adj lead))					USPAT	
170	DBR	1	4922753.pn					USPAT	
171	DBR	1	4900177.pn					USPAT	
172	DBR	1	4764184.pn					USPAT	
173	DBR	1	4720908.pn					USPAT	
174	DBR	1	4666737.pn					USPAT	
175	DBR	1	4582563.pn					USPAT	
176	DBR	1	4107726.pn					USPAT	
177	DBR	214	(molybdenum with (pad))					USPAT	
178	DBR	25	(molybdenum with (bonding adj pad))					USPAT	
179	DBR	98	wafer adj probe adj card					USPAT	
180	DBR	1	((essere.as.) and (wafer adj probe adj card)					USPAT	
181	DBR	2	(wafer adj probe adj card).ti.					USPAT	
182	DBR	132	(probe adj card).ti.					USPAT	
183	DBR	111	(probe adj card) with lead					USPAT	
184	DBR	0	"3747202"					USPAT	
185	DBR	81	(beam adj lead) same peripheral					USPAT	
186	DBR	1	5148266.pn					USPAT	
187	DBR	266	(lead with inward with (extend or extended))					USPAT	
188	DBR	61	(lead with inward with (extend or extended)) and (semiconductor adj device)					USPAT	
189	DBR	1	5148266.pn					USPAT	
190	DBR	676	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.					USPAT	
191	DBR	140	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (semiconduc					USPAT	
192	DBR	3	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (semiconduc					USPAT	
193	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent adj b					USPAT	
194	DBR	670	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent with					USPAT	
195	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent with					USPAT	
196	DBR	53	((deformable or deformed or deform or bent or bendable or bend) with lead).ab.) and (bent with					USPAT	
197	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (dis					USPAT	
198	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (fje					USPAT	
199	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (tee					USPAT	
200	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because) and (bus					USPAT	
201	DBR	0	((deformable or deformed or deform or bent or bendable or bend) with lead with because)					USPAT	
202	DBR	82	((deformable or deformed or deform or bent or bendable or bend) with lead with reason)					USPAT	
203	DBR	25	((deformable or deformed or deform or bent or bendable or bend) with lead with reason) and (semi					USPAT	
204	DBR	0	(probe adj card) and (cantilever adj lead)					USPAT	
205	DBR	4	(probe adj card) and (flexible adj lead)					USPAT	
206	DBR	4	(probe adj card) and (flexible adj lead)					USPAT	